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(Sensei) Technical Report: Distribution A

Sensei: A Multi-Modal Framework for Assessing Stress Resiliency

(August 1-31, 2013)

From:

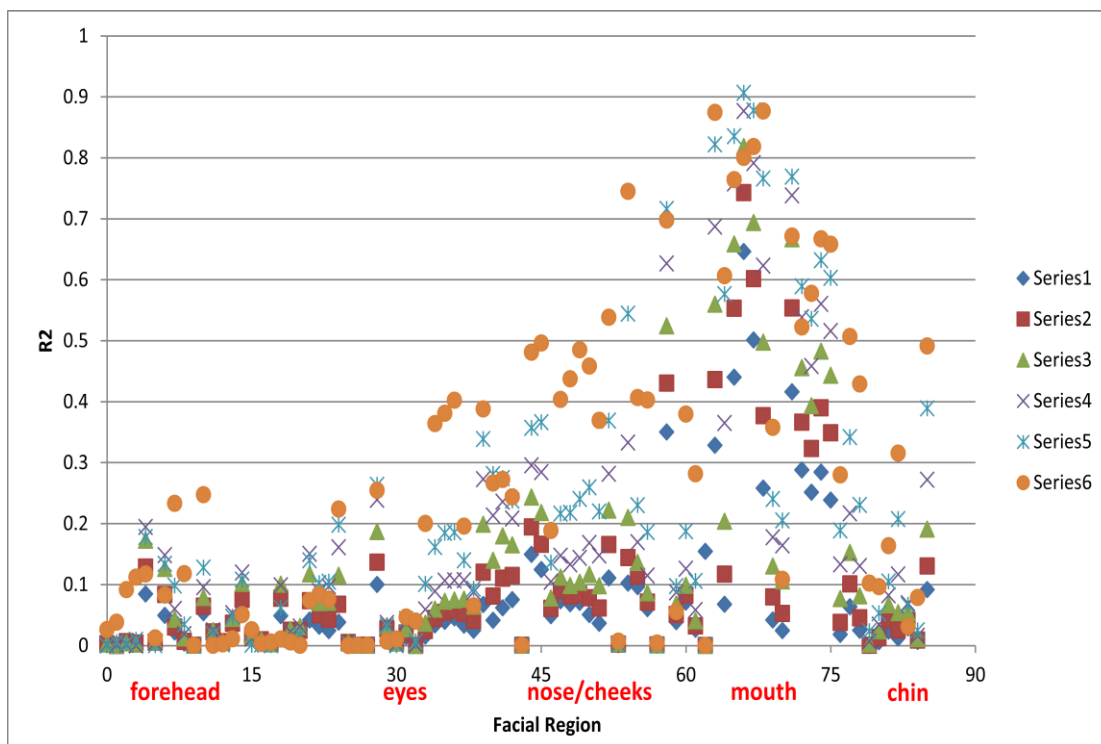
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Sensei (SRI #P21103)
Contract # N00014-12-C-0288

1 Update: Technical Progress and Accomplishments for Period 19 (August 2013):

During this reporting period, we completed development of the regression approach for predicting fingertip-based skin conductance from facial temperature dynamics, and prepared for presentation of the results of this research at the project PI meeting.

The plot below shows, for each level of temporal filtering (different symbol types and series) the correlation between fingertip-measured skin conductance and facial temperature, as a function of facial region. As predicted earlier, this plot shows an especially strong correlation (about 0.9) between skin conductance and facial cooling in the region of the upper lip.



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More details on these results will be included in the final report to be delivered before the close of the contract.

2. Issues:

- Funding has been terminated.

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